

股票代號 **7769**

「AI及綠能環保產業」 主題式業績發表會及 產業講座法人說明會簡報

(2026/04/30)



Safe Harbor Notice

This presentation may contain forward-looking statements. All statements, other than statements of historical facts, that address activities, events or developments that HON. PRECISION, INC. expects or anticipates will or may occur in the future (including but not limited to projections, targets, estimates and business plans) are forward-looking statements.

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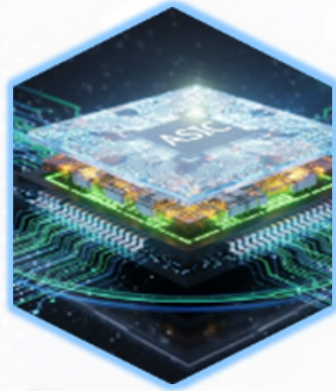
AGENDA



01

營運概況

Operation Update



02

成長動能

Growth Drivers



03

財務表現

Profitability



04

永續發展

ESG



營運概況

Operation Update

- 2026產能更新
- 訂單應用別分布
- 客戶地區分布



2026產能更新



總人力規模

2026年+50%



可使用廠房面積

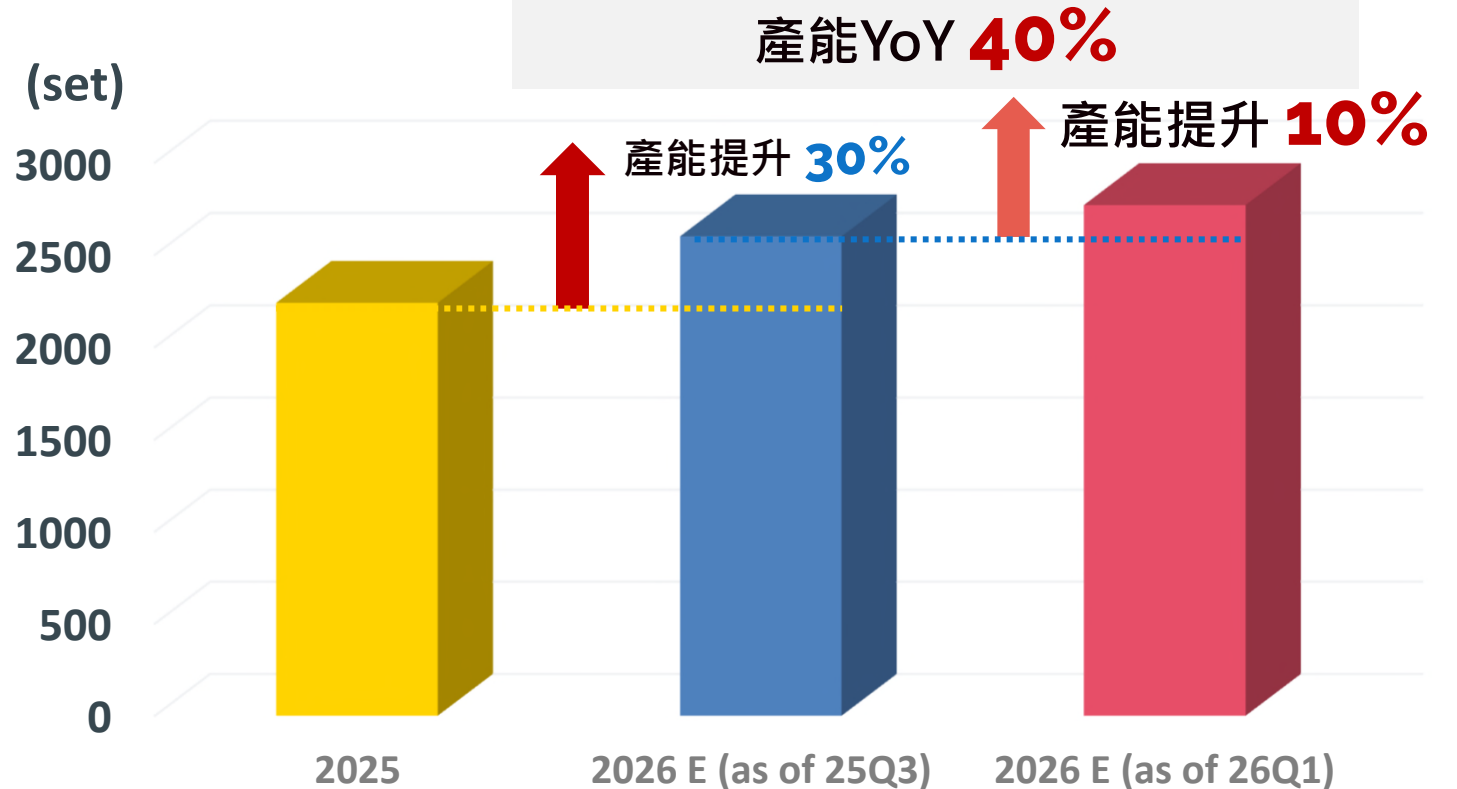
2026年+25%



採購額-加工件

2026年+40%

2026 ANNUAL CAPACITY FORECAST



訂單應用別分布

HON.PRECISION, INC.



AI
HPC
ASIC

2025 2026Q1
72% ▶ **78%**

- ▶ AI Computing
- ▶ Server
- ▶ Networking
- ▶ APU/GPU/CPU/FPGA



Automotive

2025 2026Q1
11% ▶ **9%**

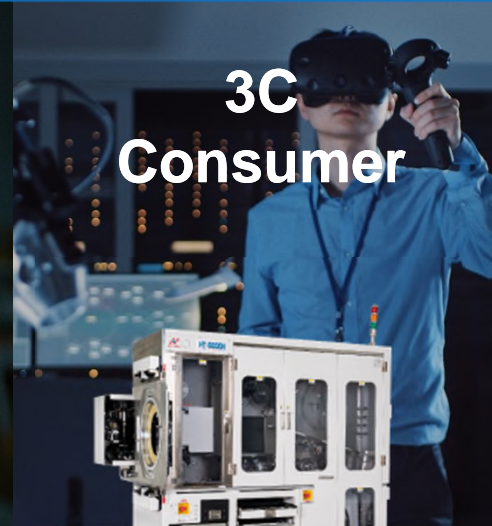
- ▶ Sensor
- ▶ MCU
- ▶ LiDAR



Mobile AP
Communication

2025 2026Q1
10% ▶ **9%**

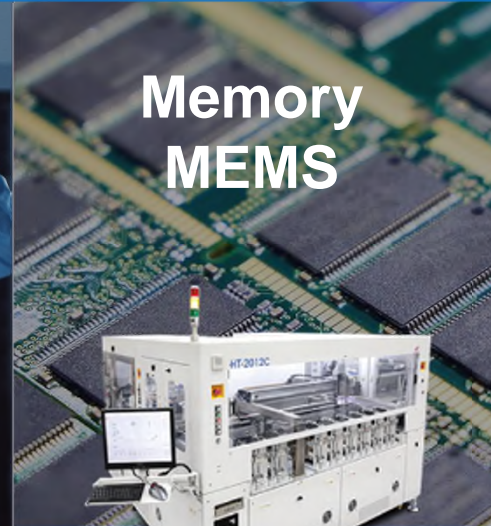
- ▶ SiP
- ▶ 5G OTA
- ▶ Power, PMIC
- ▶ Mobile Phone/AP
- ▶ RF Related Devices



3C
Consumer

2025 2026Q1
5% ▶ **3%**

- ▶ AR glasses
- ▶ LCD driver
- ▶ CIS



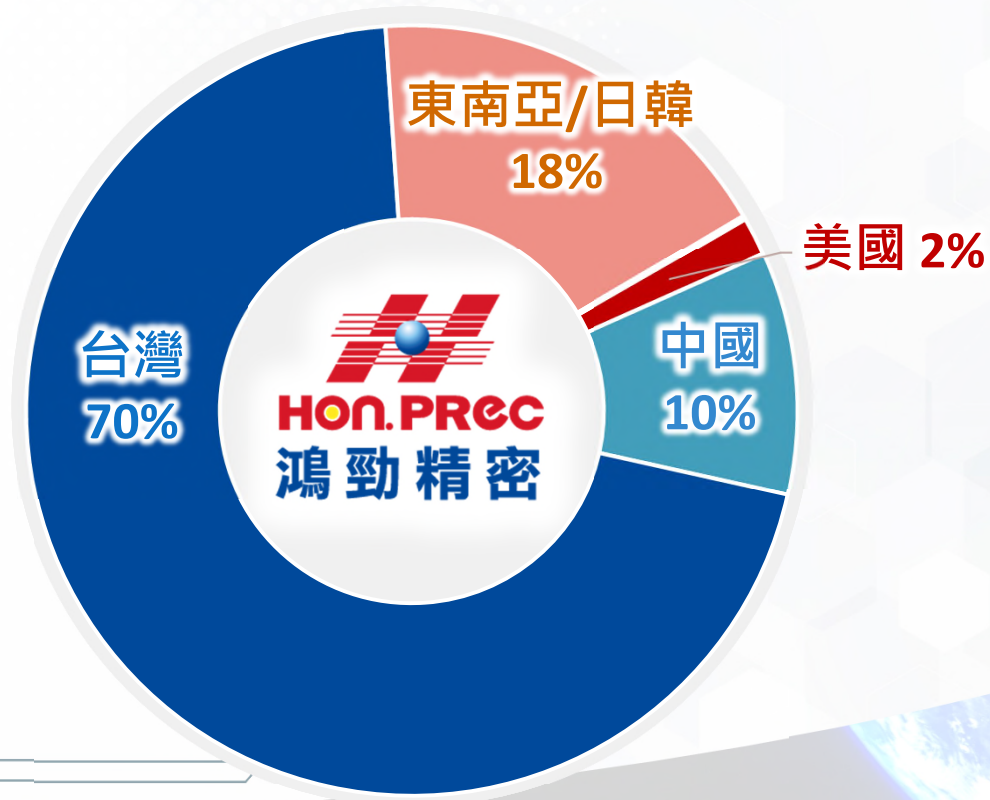
Memory
MEMS

2025 2026Q1
2% ▶ **1%**

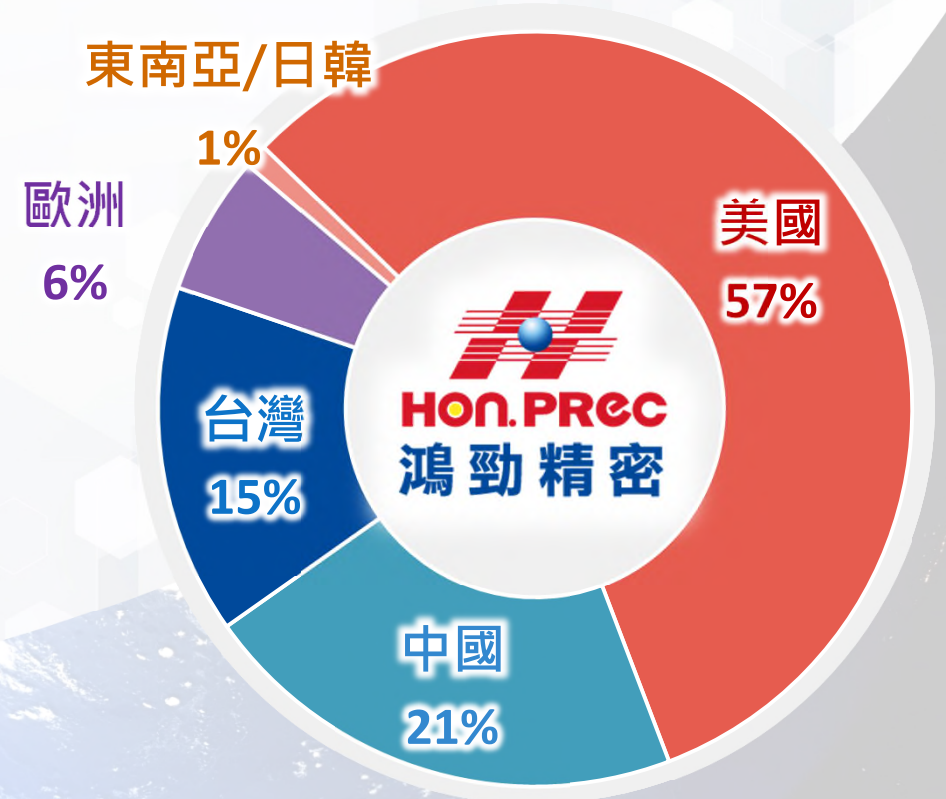
- ▶ Flash/DRAM Memory
- ▶ Accelerometer
- ▶ Gyroscope
- ▶ Barometer
- ▶ Light Sensor
- ▶ Pressure Sensor

客戶地區分布

出貨地區分布



終端客戶地區分布






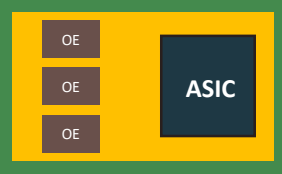
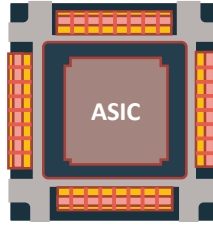
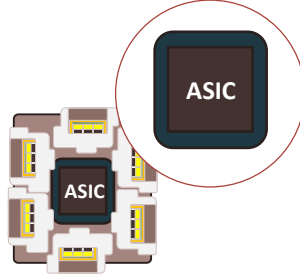
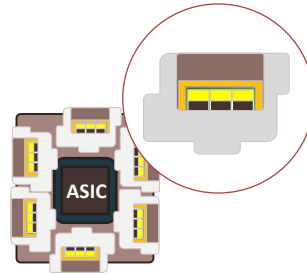
成長動能

Growth Drivers

- CPO
- 高階 FT ATC Handler 成長動能
- New Release For Final Test (FT)
- 高階 SLT ATC Handler 成長動能
- New Release For System Level IC Test (SLT)
- Active Thermal Control (ATC) Roadmap
- Cold Plate



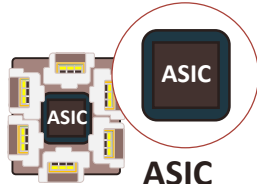
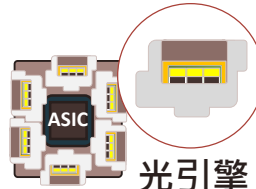
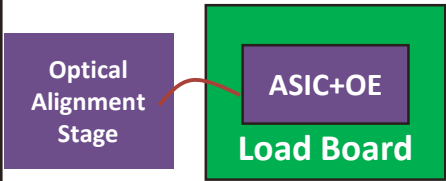

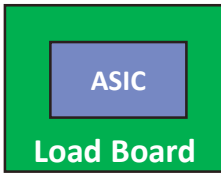
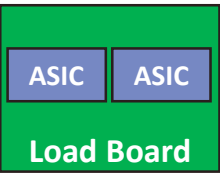
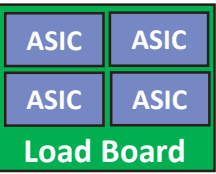
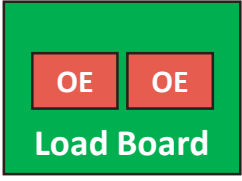


CPO Test Insertions

Test Insertion	Insertion 1	Insertion 2	Insertion 3	Insertion 4	CPO FT			
				共同開發中	量產中			
Test Content								
	PIC	EIC-PIC	光引擎	ASIC + 光引擎	ASIC + 光引擎	ASIC	光引擎	
	Wafer Level (Foundry)	Wafer Level (Foundry)	DIE/Chip Level (OSAT)	Package-Level(OSAT)				
			光電同測	電性測試	電性測試	電性測試		
HON.PREC Test Equipment	NA			ATE測試機+ATC (3KW) Handler	ATE測試機+ATC (2KW) Handler	ATE測試機+ATC (1KW) Handler	ATE測試機+ATC (1KW) Handler	



CPO Insertion 4 and FT

Test Insertion	Insertion 4	CPO FT		
	共同開發中	量產中		
Test Content	 <p>ASIC + 光引擎</p>	 <p>ASIC + 光引擎</p>	 <p>ASIC</p>	 <p>光引擎</p>
	光電同測	電性測試	電性測試	電性測試
HON.PREC Test Equipment	ATE測試機+ATC Handler			
	3000W	2000W	1000W	1000W
	Single Site	Single Site	Single/Dual/Quad Site	Dual Site
			  	

高階 FT ATC Handler 成長動能

01

高效熱管理解決方案

ATC 高功
耗測試解
決方案

02

支援客戶產能調度

支援多種
產品線

03

高階視覺檢測功能

客製化功能

NEW

04

全自動化工廠趨勢

支援
全自動化



High-End FT Handler

New Release For Final Test (FT)

CPO FT



- 光電同測 by ATE Tester
- Insertion 4
- Optical Engine & ASIC

Large Package



- 380X380 mm (Tray spec)
- 2000 kg contact force
- 支援 ATC 系統
- 支援 Full automation

MC Lid Handler



- 與合作夥伴同開發
- 自主研发機台機構及ATC 系統

WMCM Package



- 支援ATC 系統 (3000W)
- 8 / 16 sites

Top/Bottom AOI



- Top/Bottom AOI
- Current: 2D / Next: 3D

Hybrid Cooling Handler



- 支援切換氣冷/水冷/冷媒ATC
- 氣冷(16 sites)
- 水冷 (High power)

高階 SLT ATC Handler 成長動能



New Release For System Level IC Test (SLT)

Tri-Temp SLT



- -70°C~175°C (3000W)
- Support 6/8/12/20 sites

MSLT



- Full Automation
- 36~192 sites

ASIC SLT



- 25°C~150°C (3000W)
- Support 6/12/24/36 sites

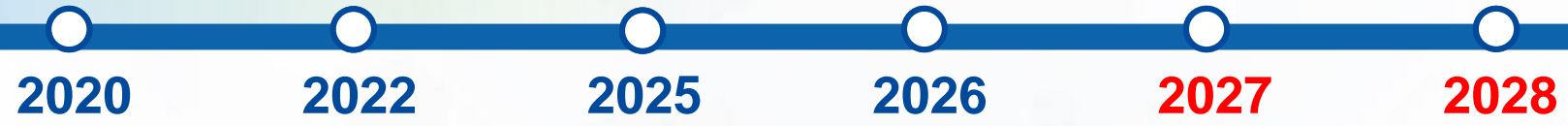
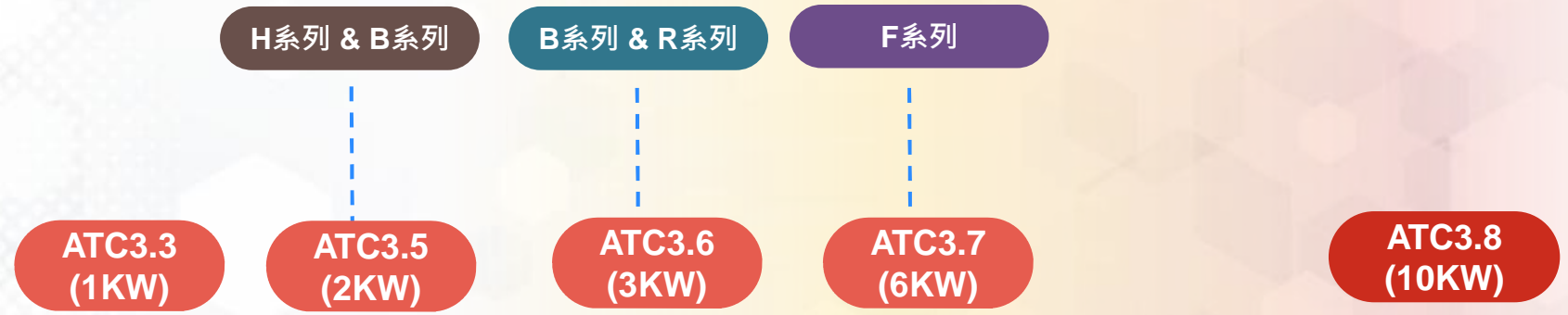
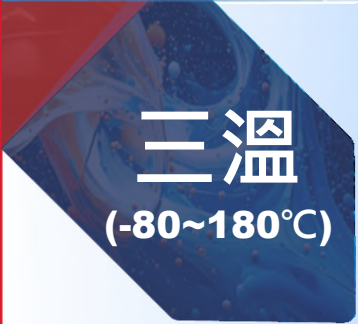
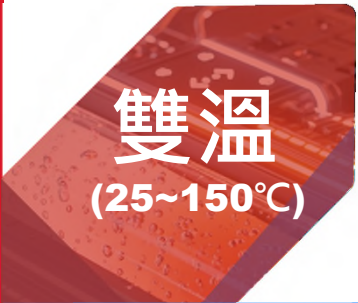
CPO 光引擎 SLT



- O/O Test

Active Thermal Control (ATC) Roadmap

HON.PRECISION, INC.



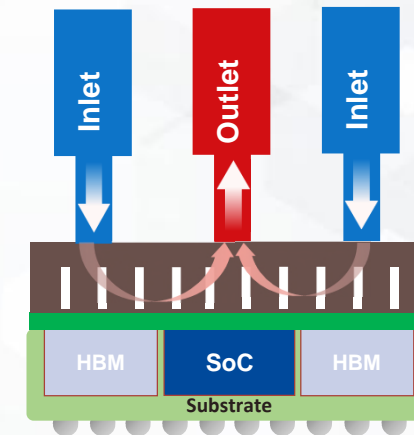
Cold Plate

Micro Channel Cold

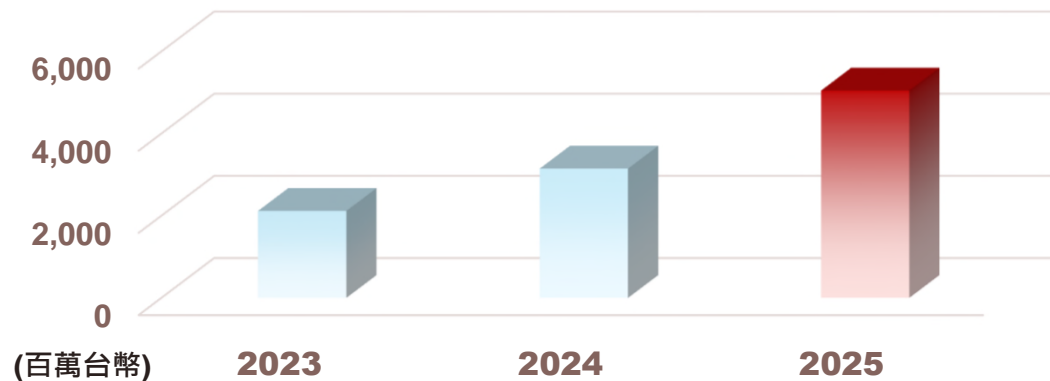
	Fin Cold Plate	MCCP
通道寬度	500um	150~200um
解熱密度	55W/cm2	120W/cm2
溫度轉換反應時間	7s	3s

Power Density
2倍
Increase

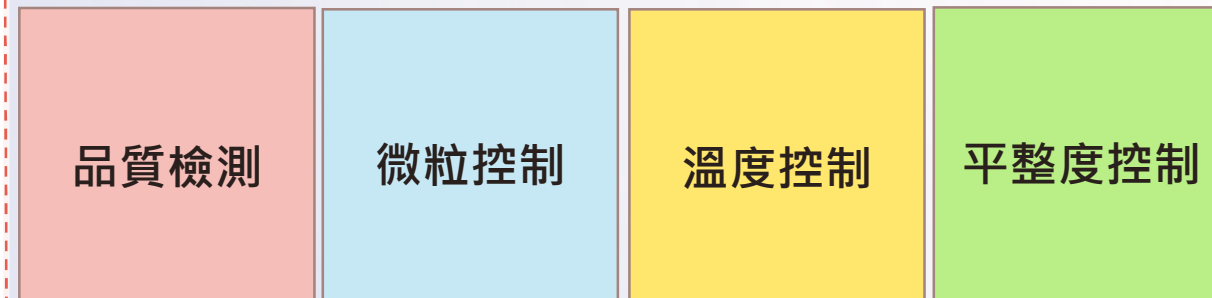
Micro Channel Lid



銷售金額



機台能力



品質檢測

微粒控制

溫度控制

平整度控制

財務表現

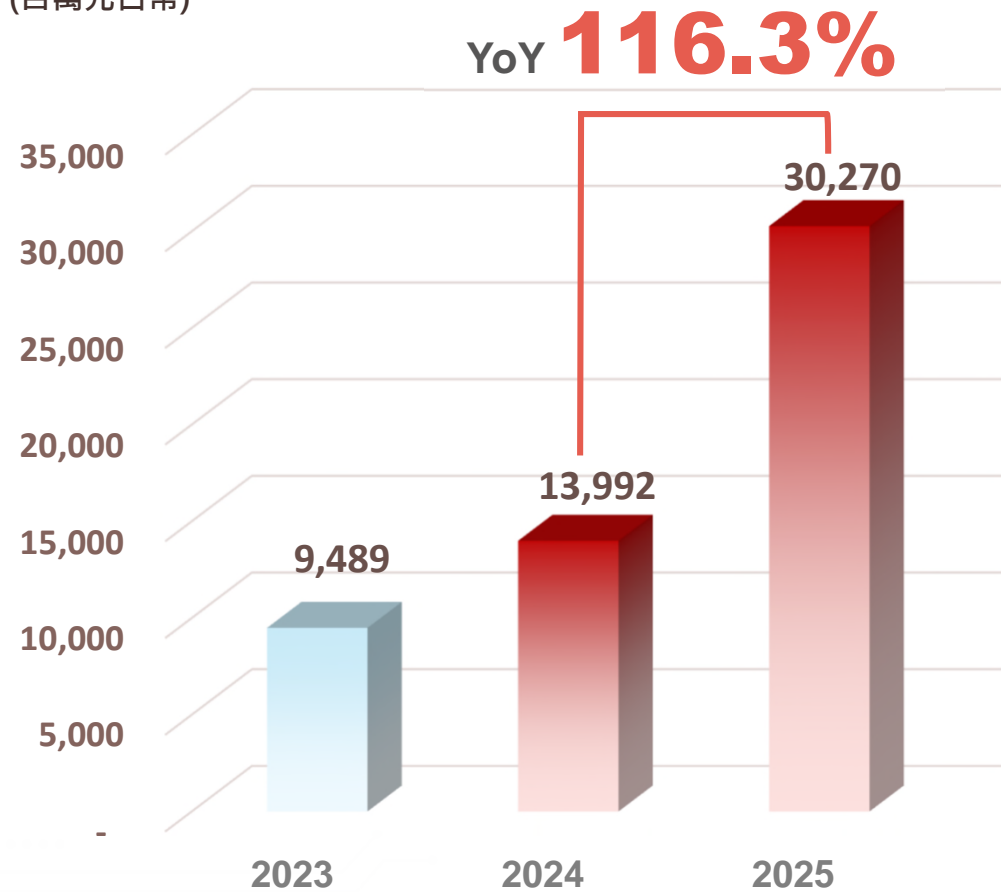
Profitability

- 營收趨勢
- 毛利趨勢
- 淨利 & EPS
- 研發費用投入

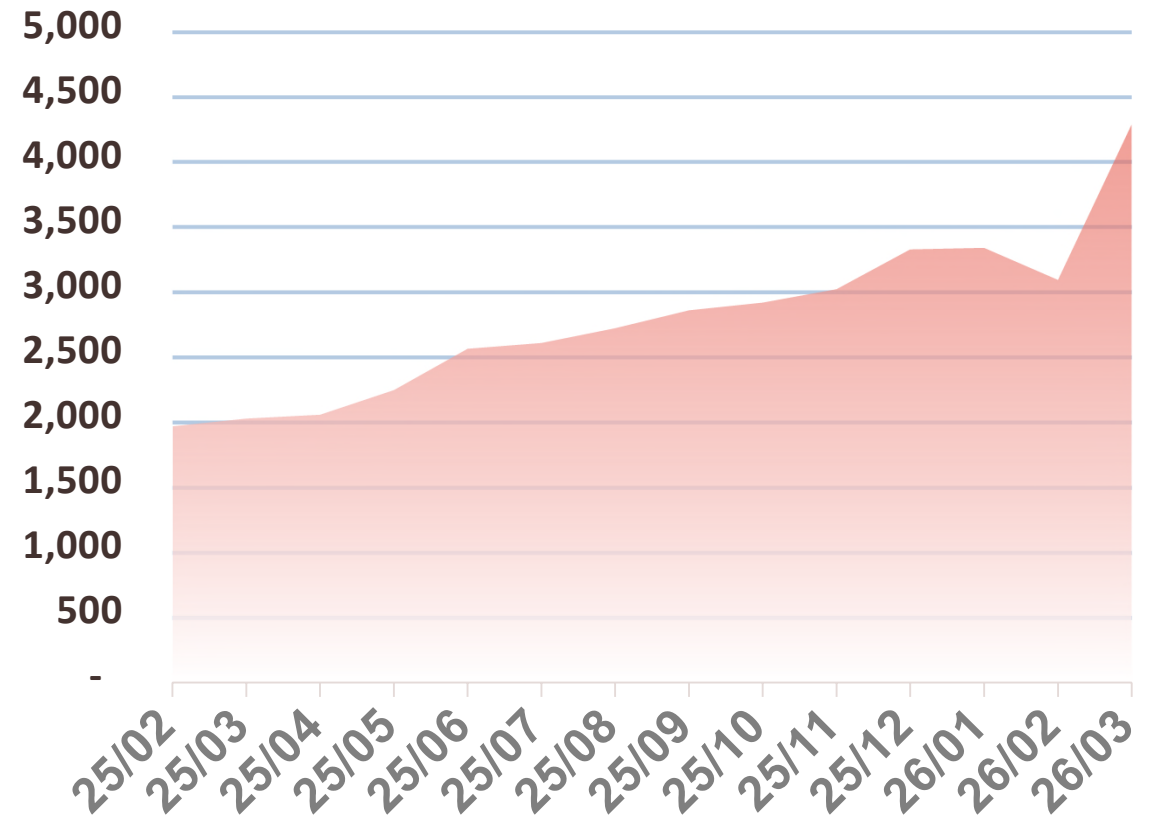


營收趨勢

(百萬元台幣)



(百萬元台幣)

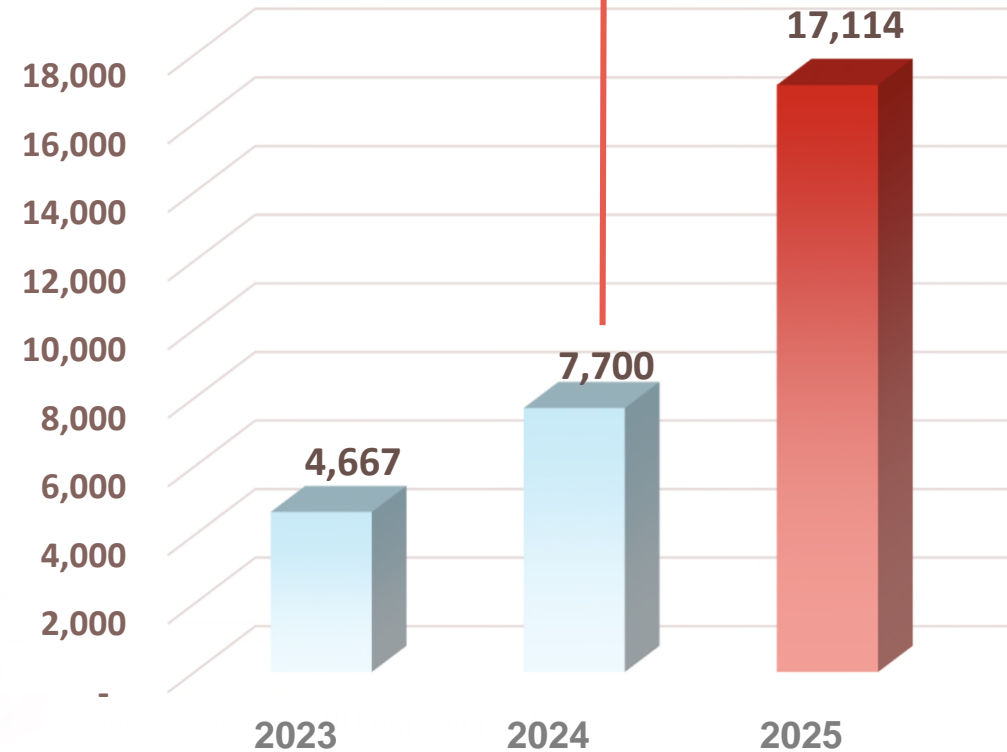


毛利趨勢

營業毛利

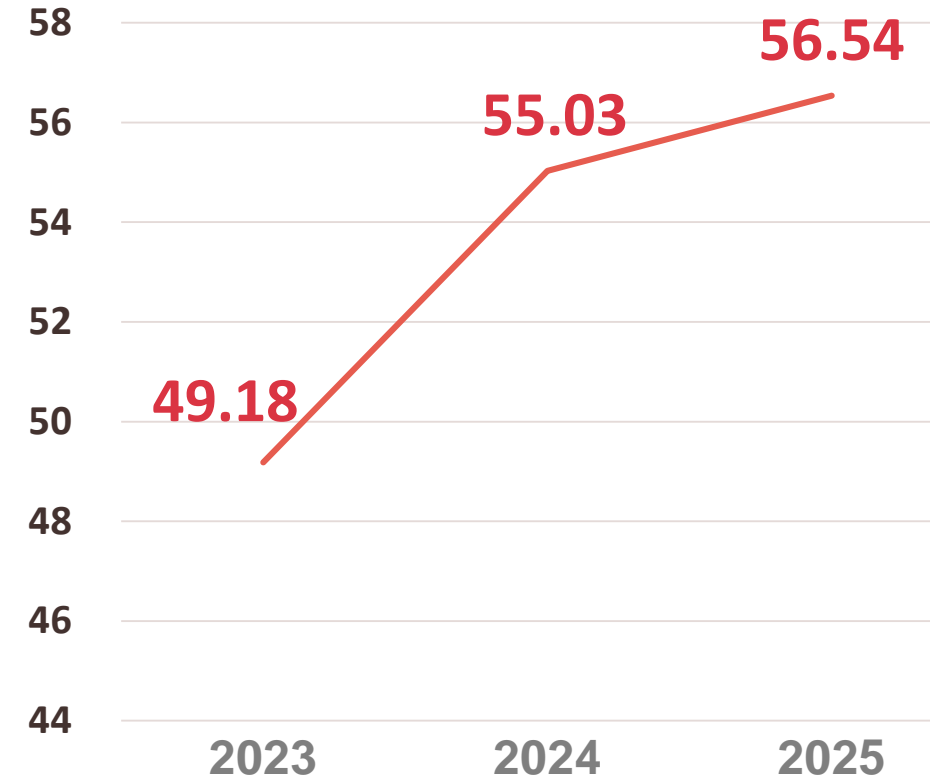
(百萬元台幣)

YoY **122.3%**



毛利率

(%)



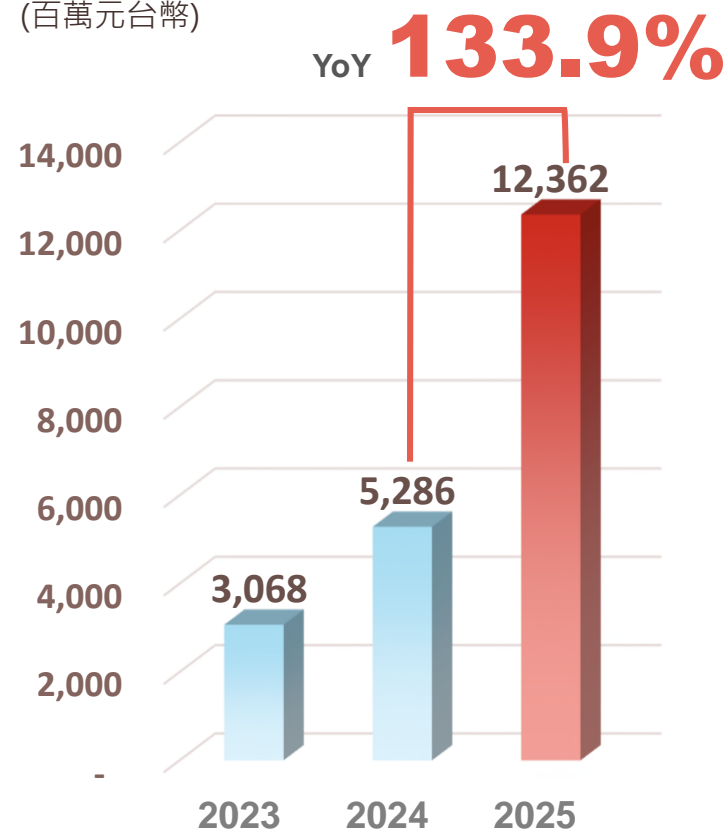
淨利 & EPS

EPS (元) 加權平均股數(仟股)

	EPS (元)	加權平均股數(仟股)
2025	75.71	163,289
2024	32.95	160,446
2023	19.17	160,000

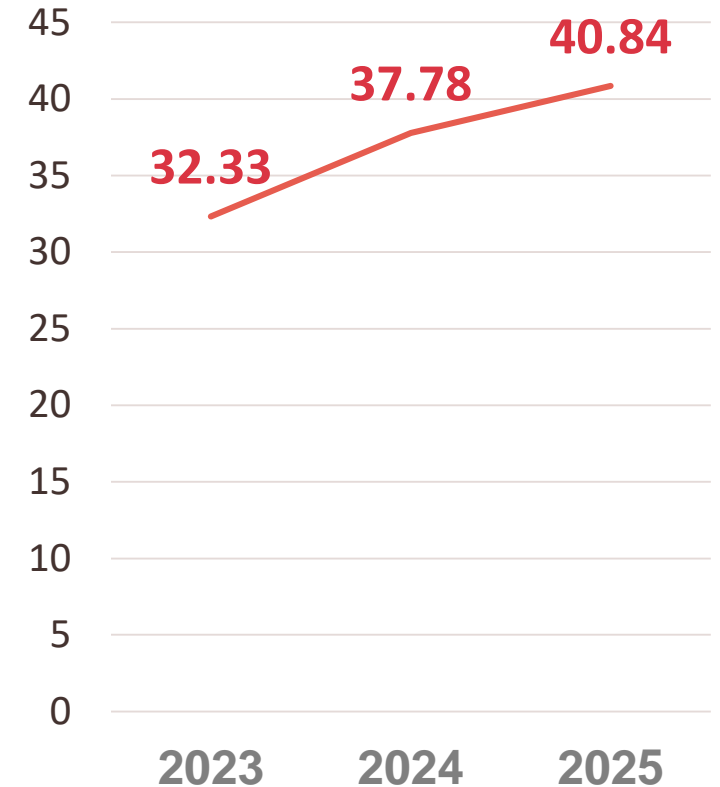
稅後淨利

(百萬元台幣)



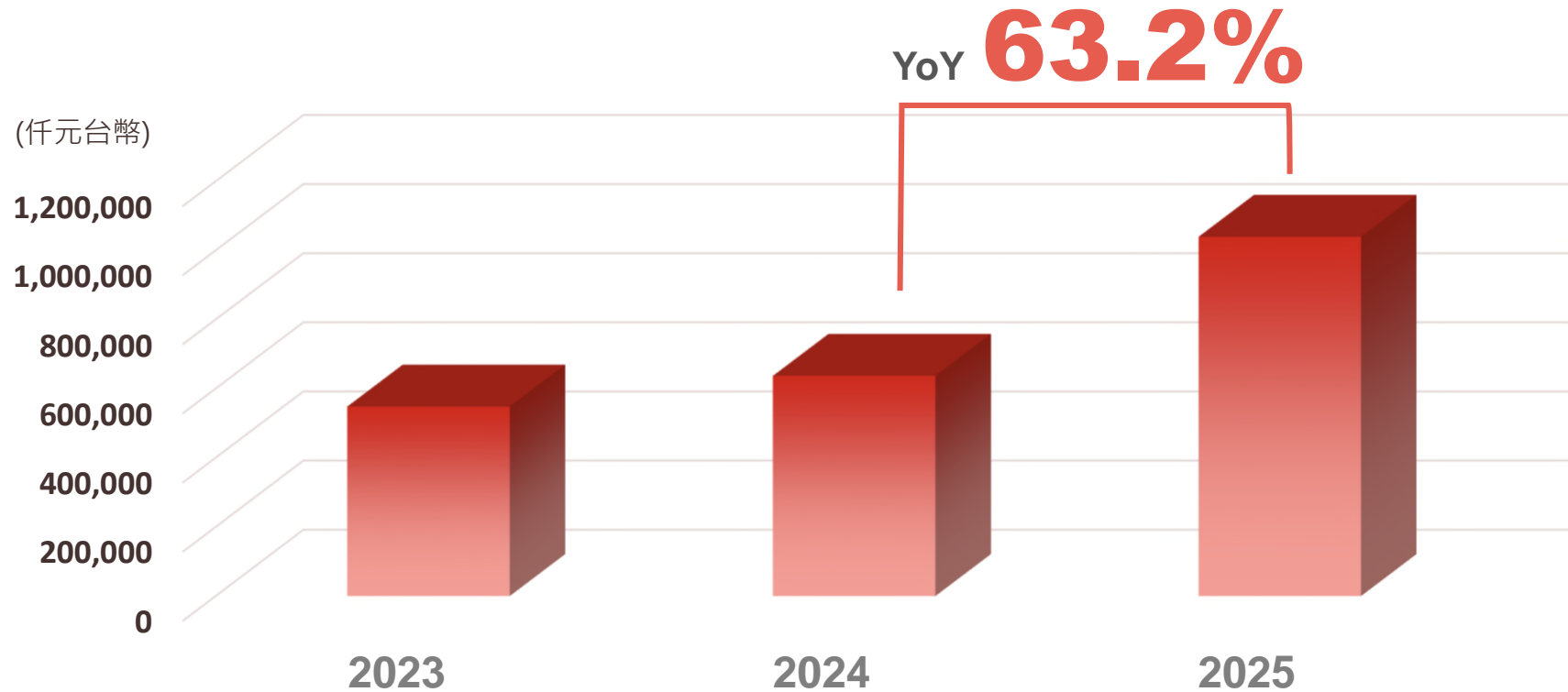
淨利率

(%)



研發費用投入

R&D



永續發展

ESG

- ESG未來發展策略
- ESG進度更新



ESG未來發展策略



環境保護 Environment

- 設置太陽能板，提升綠能使用比例
- 落實環安衛政策，確保環境安全
- 推動低碳供應鏈，減少碳足跡
- 通過 ISO 14064 溫室氣體盤查



社會責任 Social

- 關懷弱勢，參與公益活動
- 推廣運動與健康生活
- 建立幸福職場文化
- 通過 ISO 45001 職安衛認證
- **成立鴻勁公益慈善基金會(26Q1)**



公司治理 Governance

- 設置功能性委員會，提升治理效能
- 建立完善治理規章與制度



ESG進度更新

ESG Report TIMELINE



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資料收集之前置作業

- 收集永續議題收集及正負面衝擊
- 利害關係人鑑別
- 收集氣候相關財務揭露

重大議題確認

- 問卷發放與回收
- 矩陣與資料分析
- 議題決定

訪談及資料彙整

- 進行各單位訪談及收集量化資訊
- 彙整量化資訊
 - 風險管理政策
 - 溫室氣體及氣候排放
 - 能源/水資源及廢棄物管理
 - 人力資源
 - 供應鏈管理
 - 產品品質與安全
 - 資訊安全
 - 董事會及功能性委員會
 - 投資人溝通

報告撰寫及美編

- ESG 報告完成及上傳

DONE

3/9 ~ 4/15

4/16~5/15

5/16~5/31

Smarter Chips. Efficient Tomorrow.

Powered by Our Growth Drivers.

Questions & Answers

